



ISSS Journal of Micro and Smart Systems

A Technical Publication of the Institute of Smart Structures and Systems

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Special Issue on Smart Materials and its Applications

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Message from the Editors

ISSS Journal of Micro and Smart Systems will be running a ***Special Issue on Smart Materials and its Applications*** with the aim of providing the authors and readers a platform to publish and discuss the latest research and new ideas on Smart Materials. The Special Issue will be led by our Guest Editors, Prof. A Arockiarajan and Prof. Bisakh Bhattacharyya, who are expert in the field and will oversee the editorial process for manuscripts. We invite original research articles on Smart Composites, Smart Elastomers, Material Characterization, Sensor Applications, Actuator Applications, Constitutive Modelling, Mechanics and Dynamics of Smart Materials, Novel Practical Applications of Smart Materials, Intelligent System Design, Soft Robots/ Manipulators. Research work on Piezoelectric, Magnetostrictive, Electrostrictive, SMA, ER and MR Fluids, etc. materials will be considered. The deadline for submission of manuscripts for the Special Issue is 31 December, 2022.

For any inquiries related to the Special Issue, kindly contact us at journal.iss@gamil.com



Insturctions for Authors

1. Full length manuscript can be prepared as per the submission guidelines of the ISSS Journal. Kindly find the manuscript preparation guidelines here
2. The submitted manuscripts for the special issue will be reviewed in accordance with the review policies of the ISSS Journal of Micro and Smart Systems.
3. Kindly submit the full length manuscript at the email-ids provided above with the subject of the e-mail being "Special Issue on Smart Materials and its Applications". Also, the manuscript submission can be made at the submission portal provided by the Springer.
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